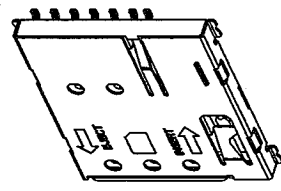
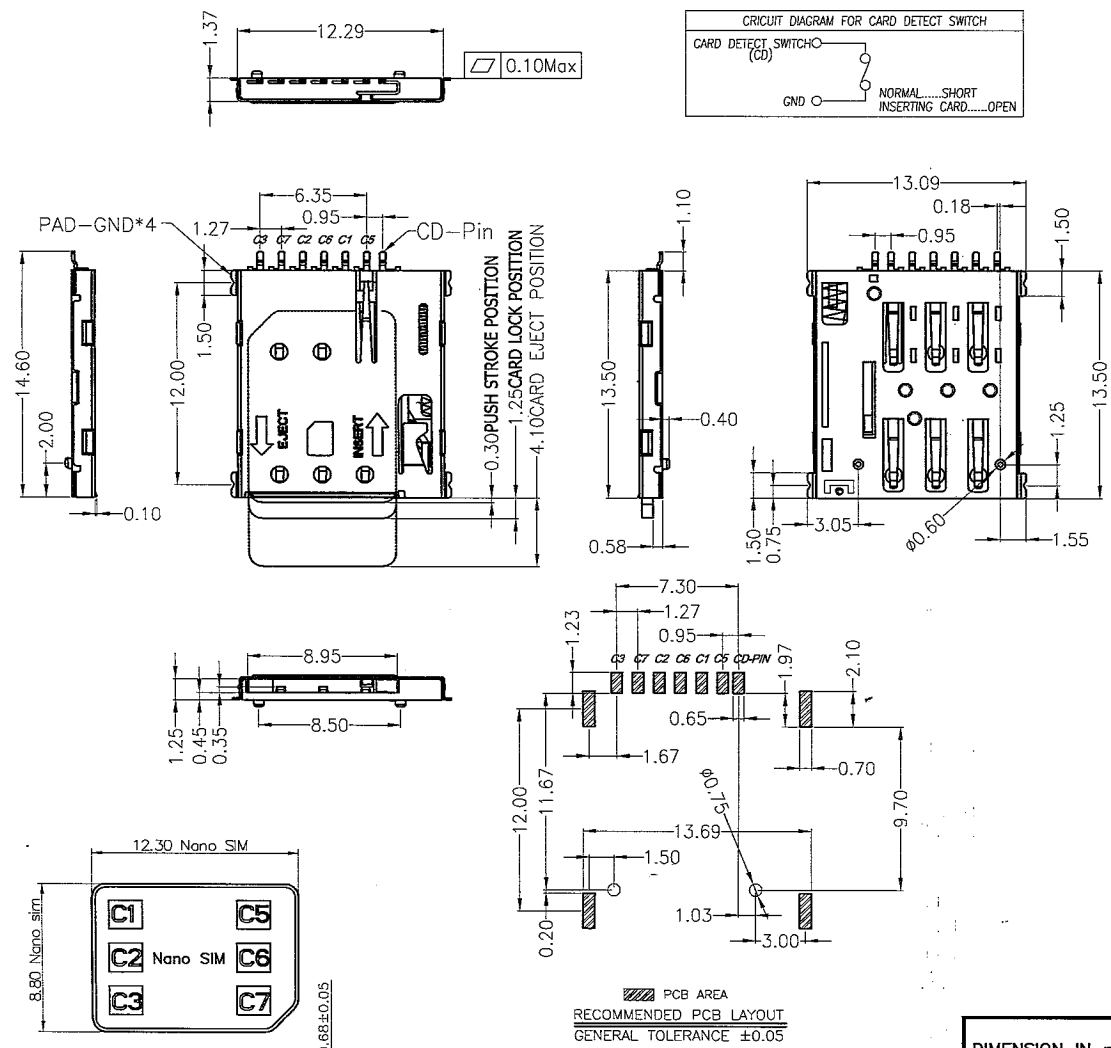


1 2 3 4 5 6 7 8

REV	MODIFICATION	DATE	DRAW
B	ECN2-00000574	2018.03.20	Moya
C	ECN2-00000697	2019.08.23	Moya

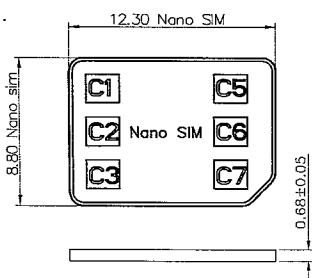
F  
E  
D  
C  
B  
A

F  
E  
D  
C  
B  
A



**MATERIALS**  
 HOUSING: THERMOPLASTIC BLACK(UL 94V-0).  
 TERMINAL: COPPER ALLOY, NICKEL UNDER PLATED OVERALL GOLD PLATED OVER ALL  
 SHELL:SUS PLATING: NICKEL PLATED OVERALL GOLD PLATED ON SOLDER TAILS

**SPECIFICATION**  
 CURRENT RATING: 0.5 AMP AC/DC MAX  
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE  
 CONTACT RESISTANCE: 100m OHMS MAX  
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 250V  
 OPERATION TEMPERATURE: -25°C~+85°C



PCB AREA  
 RECOMMENDED PCB LAYOUT  
 GENERAL TOLERANCE ±0.05

Nano-SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

ORDER INFORMATION:  
 SIMMP-N0601B01S



DIMENSION IN mm [Inch]		PROD. SPEC.	KINGFONT PRECISION INDUSTRIAL CO., LTD.	
TOLERANCE UNLESS OTHERWISE SPECIFIED		PKG. SPEC.	TITLE NANO SIM,6P, P-P H=1.35mm CUSTOMER DRAWING	
.X±0.30	.X'± 3'	APPROVE <i>Green</i>	FILE NO.	DWG NO. SIMMP-N0601B01S
.XX±0.20	.X'± 3'	CHECK <i>Benji</i>	SIZE A4	PROJ.  SHEET 1 / 1
.XXX±0.10	.XX'± 3'	DRAW <i>Moya</i>	SCALE 1:1	REV C

1 2 3 4 5 6 7 8 QR-2100-043